The AM02S Series is a PC/104 type interface product that conforms to international standards IEC 61375-3-1 MVB.

This product supports a physical transmission media called ESD(Electrical Short Distance) and uses its own developed control technology. This product is applicable to the MVB system through the Logic Bombardier TCMS level 1 MVB Conformance Test and physical layer.

You can take Interface for 3 types(SPI, Serial, I2C) through the Option choice.

- Manufactured for Compact Mini Module Type of H 70mm * 53mm Size, Which composed to be easy when manufacturing a limited Board of the Size.
- Possible to operate with a simple setting and designed for making it easy for the user to know MVB Line status and Frame information.
- You can use Process Data, Message Data, Device Status, Bus Manager through the Function options.
- It is designed for the railway industry and can operate in harsh environments.
- Suitable for humidity through coating of 30~60 µm.
- Improved EMI and vibration robustness.
- Operating temperature is -40 to +85°C.

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1164-21, Haeun-daero, Haeundae-gu, Busan, 48069, Republic of Korea Tel. +82-51-742-1324 | Fax. +82-51-701-1324 | Mail. staff.ants@gmail.com This product specification is also available in PDF format at www.e-ants.co.kr



Data sheet Preamble

1. Customer Rights

As you purchase the product described in this Data Sheet, the purchaser has the right to use it based on the specified purpose and operation of the product, service and maintenance instructions of the product. However, ANTS has other rights including intangible assets.

2. Product Validity

The properties of the product are described in the Data Sheet and are valid until the warranty period on the basis of the order date.

3. Customer Obligations

Buyers must verify that the product is suitable for their purchase intent. Designing systems and applications within supply coverage of ANTS is guaranteed in normal operation, but if the system is configured with other products, malfunctions may occur and be required corresponding action.

4. Quality Assurance

The product warranty is according to ANTS discretion and is subject to repair or replacement at the ANTS factory. The warranty covers of the products that are stocked due to defects in spite of the proper handling. Does not warrant the defects and loss caused by negligence or misuse against property of the products presented by ANTS. The warranty period of the product is 36 months and managed as a serial number from the date of shipment. The warranty does not cover products with defects and warranties due to connection with other products.

5. Other

You must bear the cost of any indirect loss incurred due to non-delivery of the product or warranty. Basically, it is not possible to cancel after order, and the cost of the loss should be defrayed by the buyer.

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1. Introduction

The AM02S series was developed for the control of railway vehicle MVB systems and has been verified in real vehicles through numerous projects and work at home and abroad.

It has been verified as functional conformity through IEC 61375–3–2 IEC Standard for Train Communication network and Part 3–2: MVB(multifunction vehicle bus) conformance testing according to TCN standard IEC 61375–3–1. Logic used in this product has been verified by Bombardier TCMS level 1 MVB conformance test.

The AM02S Series is built in the form of ANTS's own Mini Form factor.

For Interface and space reasons, PC/104 products can be easily applied in Compact Type to a structure that is difficult to use.

Be designed checking to easy user needed information such as MVB Line status and Frame information. Process Data, Message Data, Device Status, Bus manager functions can be selected and used according to the user's application according to the Mount Option.

To meet railway environmental conditions, it consists of industrial devices with a working range of -40 to +85°C. Suitable to humidity through 30 to 60μ m coatings and robust against EMI design and vibration.

SUPPORT

- · You can get new products, latest data sheets and program source materials by visiting our website.
- · Supports meetings and demonstrations from sales person if you place large orders.
- · You can easily purchase demo or development boards from the online marketplace.
- · This product specification is also available in PDF format at www.e-ants.co.kr



2. Block Diagram

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2-1. Hardware Structure

It is representative model of AM02S Series equipped with Header Connector.



⟨Figure 1-1. Hardware Image⟩

ltem	Spec
FPGA	Up to 16K Logic / Up to 54 Kb Memory / Embedded Flash
Traffic Memory	1M * 16bit SRAM, 10ns Speed
MVB Interface	EMD – Transformer Isolation
MVB Function	Class 1, 2, 3 (Optional 4)
MVB Connector	2.54mm Header 10pin / 2.54mm Header Socket 10pin (Option)
Host Interface	SPI, I2C (Opt), Serial (Opt)
Host Interface Connector	2.54mm Header 14pin / 2.54mm Header Socket 14pin (Option)
Dimension	90 * 96 * 25mm, PC/104 Form factor
Operation Temperature	−40 ~ +85°C
Power	5VDC ±0.25V, 5V

⟨Figure 1-2. Hardware Spec⟩

2. Block Diagram

2-1. Hardware Structure

This Figure is basic hardware configuration diagram of the AM02S Series.



⟨Figure 1-3. Hardware Structure⟩

ltem	Spec
MVB Controller	MVB Interface and Traffic Memory management
PC/104 Interface	Host System and Data Communication Interface, depending on the operating Mode, connect the input and output signals
Traffic Memory	Memory that shares Data transmitted and received by MVB and Data transmitted and received by $PC/104$
MVB Interface	MVB driver and transformer, ESD interface supported by transformer isolation
Debug Serial	Frame Counter status information of Master and Slave can be checked with 3.3V Serial
State Lamp	MVB Line status and internal Board status can be checked

⟨Figure 1-4. Hardware Spec⟩



2. Block Diagram

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2-2. Logic Structure



⟨Figure 2-1. MVB Logic Structure⟩

ltem	Spec
Encoder/Decoder	Create MSD/SSD/ED, Data Encoding and Decoding, Calculate Check Sequence
Transmit Buffer	Data Buffer to transfer
Receive Buffer	Received Data Buffer
MVB Control Unit	Switchover, Mastership Transfer, Master/Slave transmission and reception
Master Memory	When Master function is executed, it is saved in Master List
Arbitration/Memory Controller	Interfacing between PC/104 and Master Memory and Traffic Memory

⟨Figure 2-2. MVB Logic Spec⟩

3. MVB Interface

3-1. Pin Assignment for the ESD Connector

ESD(Electrical Short Distance) MVB connector should check the Option information of ordering information before ordering.

• J1. MVB Connector

Dsub	Pin Name	Pin Description
1	A. Data P	Positive Wire of Line A
2	A. Data N	Negative Wire of Line A
3	B. Data P	Positive Wire of Line B
4	B. Data N	Negative Wire of Line B
5	A. Bus GND	Ground Line A
6	B. Bus GND	Ground Line B
7	A. Bus 5V	Positive Supply Line A
8	B. Bus 5V	Positive Supply Line B
9	Shield	Housing Shield
Shield	Shield	Housing Shield

⟨Figure 3-1. MVB Connector Spec⟩

3-2. MVB Connector Option

Free to choice for Connector Type what suitable for MVB Board structure and order it. Please before placing an order, check the Option of Ordering Information.



(Option K) Straight Top Socket 10pin

(Option L) Straight Bottom Header 10pin



4. SPI, Serial, I2C Interface

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4-1. Pin Assignment for the SPI, Serial, I2C Connector

In compliance with the Mini Form factor, the SPI Interface is built as standard specification. Please check the Ordering Information Option before selecting Serial and I2C Interface.

Dsub	Pin Name	Pin Description		Dsub	Pin Name
1	+5V	Mini Module Operation Power		8	SS
2	+51/	Mini Module Operation		9	SERI RX
2	100	Power		10	SERI TX
3	LA	MVB Line A State		11	SCI
4	LB	MVB Line B State			UUL
5	SCLK	SPI Serial Clock		12	SDA
6	MOSI	SPI Master Out/Slave In		13	GND
7	MISO	SPI Master In/Slave Out		14	GND
	Dsub 1 2 3 4 5 6 7	Dsub Pin Name 1 +5V 2 +5V 3 LA 4 LB 5 SCLK 6 MOSI 7 MISO	DsubPin NamePin Description1+5VMini Module Operation Power2+5VMini Module Operation Power3LAMVB Line A State4LBMVB Line B State5SCLKSPI Serial Clock6MOSISPI Master Out/Slave In7MISOSPI Master In/Slave Out	DsubPin NamePin Description1+5VMini Module Operation Power2+5VMini Module Operation Power3LAMVB Line A State4LBMVB Line B State5SCLKSPI Serial Clock6MOSISPI Master Out/Slave In7MISOSPI Master In/Slave Out	DsubPin NamePin DescriptionDsub1+5VMini Module Operation Power82+5VMini Module Operation Power93LAMVB Line A State104LBMVB Line B State115SCLKSPI Serial Clock136MOSISPI Master Out/Slave In14

• J5. Interface Connector

Dsub	Pin Name	Pin Description
8	SS	SPI Slave Select
9	SERI RX	Serial Receiver Data
10	SERI TX	Serial Transceiver Date
11	SCL	I2C Serial Clock
12	SDA	I2C Serial Data
13	GND	Mini Module Ground
14	GND	Mini Module Ground

⟨Figure 4–1. MVB Connector Spec⟩

4-2. Interface Connector Option

You can freely choose and order Host Interface Connector Type according to MVB Board mounting structure. Please before placing an order, check the Option of Ordering Information.



(Option G) Mini Mount Top Socket 14pin



(Option H) Mini Mount Bottom Header 14pin

5. Debug Interface

The debug Serial Interface uses a Serial 3.3V level signal and can identify Master and Slave Frame/Error Counter in line A and B.

• J8. Debug Serial

Number	Pin Name	Property
1	RXD	3.3V Serial Receiver Data
2	TXD	3.3V Serial Transmitter Data
3	GND	Serial GND



6. Mechanical Data

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6-1. Component Layout



{Top Component Layout>



(Bottom Component Layout)

6-2. Dimensional Data

4-ø6.5 Pad ø3.2 Holes



(MVB Mini Bottom Type)





(Mini Module Stack Configuration)

7. Technical Note

7-1. State LED

Number	Pin Name	Property
D1	TXD	Debug Serial TX Flickering on transmission
D2	Master	Lights On when Master is set in Class 4
D3	RXD	Debug Flashing on receiving Serial RX
D4	Class	Class 1 to 3 Lamp off, Class 4 Lamp on
D5	FPGA	Flashing during FPGA operation
D6	Start	Lights On when Start is set
D7	Power	Lights On when power is on
D8	Line A	Lights On when occupying MVB Line A
D9	Line B	Lights On when occupying MVB Line B

7-2. PC/104 Timing Diagram



⟨Write/Read Timing Diagram⟩



7. Technical Note

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7-3. SPI Timing Diagram

You can freely choose and order PC/104 Connector Type according to MVB Board mounting structure. Please check the option information of ordering information and place an order.



(Write/Read Timing Diagram)

7-4. Power Up and Reset Sequence

It takes about 2 seconds to set up the FPGA and Traffic Memory at power-on and after can be used via PC/104 later.

8. Standard and Certification

8-1. IEC 61375-3-1, IEC 61375-3-2 Standard Reference

8-2. Environment Test Standard Reference

Data/No	Subject
IEC 61373:2010	Railway applications-Rolling stock equipment-Shock and Vibration tests(Category 1/Class B)
IEC 60571:2012	Railway applications-Electronic equipment used on Rolling stock
IEC 60068-2-1:2007	Environmental testing-Part 2-1: Tests A: Cold, Test Ad
IEC 60068-2-2:2007	Environmental testing-Part 2-2: Tests B: Dry heat
IEC 60068-2- 14:2009	Environmental testing-Part 2–14: Tests N: Change of Temperature
IEC 60068-2- 30:2005	Environmental testing-Part 2-30: Tests Db: Damp heat(12h+12h Cycle)
IEC 61000-4-5:2014	Electromagnetic compatibility(EMC)-Part 4-5: Testing and Measurement techniques-Surge immunity test
IEC 61000-4-2:2008	Electromagnetic compatibility(EMC)-Part 4-2: Testing and Measurement techniques-Electrostatic discharge immunity test
IEC 61000-4-4:2012	Electromagnetic compatibility(EMC)-Part 4-4: Testing and Measurement techniques-Electrical fast transient/Burst immunity test
IEC 61000-4-3: 2006+A2:2010	Electromagnetic compatibility(EMC)-Part 4-3: Testing and Measurement techniques-Radiated, Radio-Frequency, Electromagnetic field immunity test
IEC 61000-4-6:2013	Electromagnetic compatibility(EMC)-Part 4-6: Testing and Measurement techniques-Immunity to Conducted disturbances, Induced by Radio-Frequency fields
CISPR 11:2015	Industrial, Scientific and Medical equipment-Radio-Frequency disturbance characteristics-Limits and Methods of Measurement



8. Standard and Certification

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8-3. MVB Conformance Test

We have passed the Bombardier TCN Level 1 MVB Conformance Test to verify the reliability of our MVB products.

	r: Responsible Unit: Document type: TTT Test Report				BOMBARDIE			
Prepared	wed			Docume	nt state:			
Checked			(8.0.1.)	TCMS Level	TCMS Level 1 MVB Conformance Test		2ECM0	0720004070
				ANTS Co.,Ltd E	SD Ethernet/USB Contro	oller	SEGMU	0720004079
Approved 2017-10-	-11	G. Hans	(s.o.f.)	File name: 3EGM007200D4079 TCMS L Converter	evel 1 MVB Conffest_ANT8_E8D Ethemet	USB		en 1/20
Test Ob	bject:			ANTS Co.,Ltd ESE	Ethernet/USB Controller	r		
Identifi	catior	n No:		S/N: AP-MVB-P00	2-A0 Rev.: A0			
Test Da	ate:			2017-08-31 and 20)17-09-29			
Particin	pants							
Function			Departr	nent	Name			
Tester			ттт		Thorsten Flüg	gel		
Kind of	lest	:	Intero	perability test				
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9. Ordering Information

Please refer to Ordering Information when ordering the product.

ORDERING INFORMATION							
AM02S	_0_	1 Series					
Class		Interface Option					
1 – Class 1 (Process Data) 2 – Class 2 (Message Data) 3 – Class 3 (Message Data) 4 – Class 4 (Bus Administration, Master)		2 – Serial 3 – SPI 4 – I2C					
MVB Connector Option K – Straight Top Socket L – Straight Bottom Header		Mount Connector Option G – Mini Mount Top Socket H – Mini Mount Bottom Header					